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(54) Title: APPARATUS AND METHOD FOR SEPARATING ELECTRONIC COMPONENTS

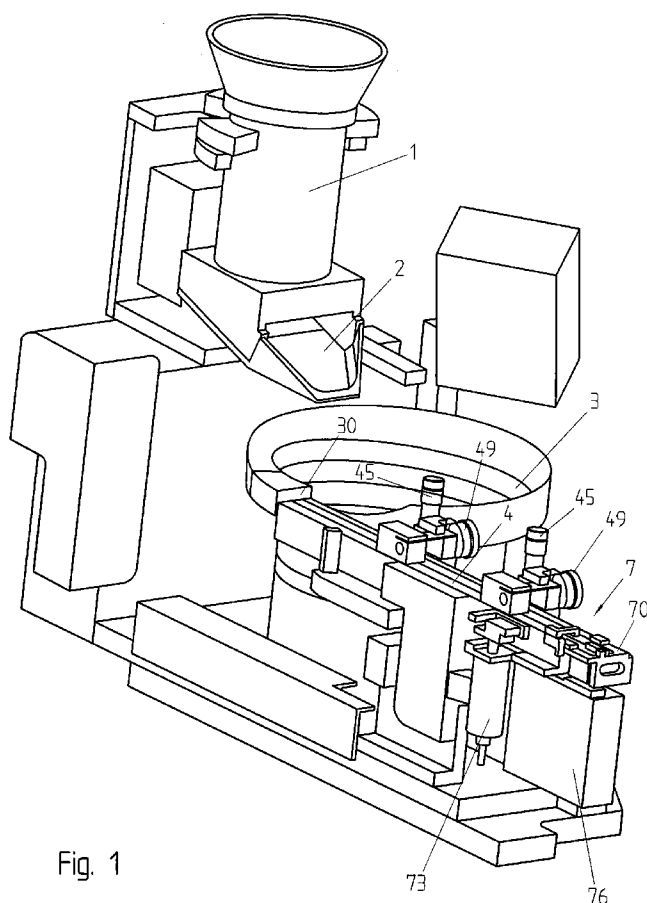


Fig. 1

(57) Abstract: An apparatus for isolating electronic components, comprising: a feeder track for moving a row of electronic components (6) to be isolated along a path, an abutment (71) at the end of said path, arranged for preventing displacement of the leading component in said row further than a predefined abutment position, a movable stop element (72, 74) at a fixed position along said path, for separating the leading component on one side of said stop element from all the components on the other side of said stop element, a carriage (70) for translating the electronic component (6) separated by said stop element (72, 74) at a predefined removal position where it can be gripped.

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